

IPC-ERFA meeting November 19, 2008

Held at HYTEK, Sofievej 61, 9000 Aalborg

Agenda

- 10:00 **Welcome**
 ▪ *By Alex Christensen, HYTEK*
- 10:05 **News from IPC**
 ▪ *By Alex Christensen, HYTEK*
- 10:10 **PCB Technology Roadmaps**
 What technology is needed in Europe to stay competitive? Based on the existing roadmaps, technologies are discussed that will help the PCB industry in Europe to stay competitive.
 ▪ *By Michael Weinhold, EIPC (European Institute of Printed Circuits)*
- Cost reduction in PCB fabrication**
 What is required by the OEM (designers) and the PCB fabricator to reduce cost for electronic devices made in Europe? (Here some of the developments from Japan will be reviewed and discussed what the European electronic industry could learn from it)
 ▪ *By Michael Weinhold, EIPC (European Institute of Printed Circuits)*
- 11:20 - **Status of translation and certification efforts**
 - **New 610D Automotive Addendum**
 - **Space hardware addendums for 001 and 620**
 - **New J-STD-075 Classification of Non-IC Electronic Components for Assembly Processes**
 ▪ *By Jack Crawford, IPC*
- 12:00 **Lunch**
- 13:00 *continued...*
 - **Status of translation and certification efforts**
 - **New 610D Automotive Addendum**
 - **Space hardware addendums for 001 and 620**
 - **New J-STD-075 Classification of Non-IC Electronic Components for Assembly Processes**
 ▪ *By Jack Crawford, IPC*
- 13.45 **Discussions in groups**
- 14:30 **Evaluation of group discussions**
- 15:00 **AOB.**
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